

2344GN-HF-VB Datasheet

N-Channel 30-V (D-S) MOSFET

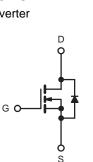
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
30	0.030 at V _{GS} = 10 V	6.5	4.5 nC			
50	0.033 at V_{GS} = 4.5 V	6.0	4.5110			

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

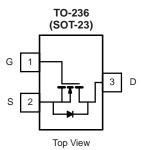
APPLICATIONS

DC/DC Converter





COMPLIANT HALOGEN



N-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		6.5 ^a	
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		6.0	
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _A = 25 °C	I _D	5.3	
	T _A = 70 °C	1	5.0	A
Pulsed Drain Current		I _{DM}	25	
	T _C = 25 °C		1.4	
Continuous Source-Drain Diode Current	T _A = 25 °C	Is	0.9 ^{b, c}	
	T _C = 25 °C		1.7	
Maximum Power Dissipation	T _C = 70 °C	P _D	1.1	W
	T _A = 25 °C	טי	1.1 ^{b, c}	VV
	T _A = 70 °C		0.7 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C
Soldering Recommendations (Peak Temperations		260		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	90	115	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60	75	5 0/10		

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 130 °C/W.

Symbol	Test Conditions	Min.	Тур.	Max.	Unit
			T		•
V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
$\Delta V_{DS}/T_{J}$	lp = 250 µA		31		mV/°
$\Delta V_{\text{GS(th)}}/T_{\text{J}}$	1 <u>0</u> – 200 p/(- 5		
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.7	1.1	2.0	V
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
lace	$V_{DS} = 30 V, V_{GS} = 0 V$			1	μA
'DSS	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			10	μΑ
I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	10			Α
Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.2 \text{ A}$		0.030		_
R _{DS(on)}	V _{GS} = 4.5 V, I _D = 2.8 A	-			Ω
9 _{fs}	V _{DS} = 15 V, I _D = 4.8 A		11		S
<u> </u>			<u> </u>		<u> </u>
Ciss			335		
	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		45		pF
	$V_{DS} = 15 \text{ V}, V_{CS} = 10 \text{ V}, I_{D} = 3.4 \text{ A}$			6.7	nC
al Gate Charge Q _g				-	
Q _{as}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 3.4 \text{ A}$		0.85		
			0.65		
-	f = 1 MHz	0.8		8.8	Ω
	$V_{DD} = 15 \text{ V. } \text{R}_1 = 5.6 \Omega$			75	-
	55 2			-	
					ns
	$V_{DD} = 15 V R_1 = 5.6 \Omega$		-	-	-
			Ű	10	
	T _C = 25 °C			1.4	[
	Ű				A
	$I_{S} = 2.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.8		V
	0 200				ns
					nC
	$I_F = 2.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$				
t _b			4		ns
	$\begin{tabular}{ c c c } \hline V_{DS} & $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$	$\begin{tabular}{ c c c c } \hline V_{DS} & V_{GS} = 0 \ V, \ I_{D} = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS(th)}/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{GS} = 10 \ V, \ I_D = 3.2 \ A \\ \hline V_{GS} = 15 \ V, \ I_D = 2.8 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 4.8 \ A \\ \hline \hline \\ \hline$	$\begin{tabular}{ c c c c c } \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 0.7 \\ \hline I_D = 250 \ \mu A & 0.7 \\ \hline V_{DS} = 0 \ V, \ V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & 10 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & 10 \ V & 10 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 10 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 10 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 10 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 10 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 10 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 10 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 10 \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V & 10 \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 3.4 \ A \\ \hline \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 3.4 \ A \\ \hline \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 3.4 \ A \\ \hline \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 3.4 \ A \\ \hline \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 3.4 \ A \\ \hline \hline P_{DD} = 15 \ V, \ R_L = 5.6 \ \Omega \\ \hline I_D \cong 2.7 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 2.7 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline \hline T_t & V_{DD} = 15 \ V, \ R_L = 5.6 \ \Omega \\ \hline I_D \cong 2.7 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline \hline T_t & V_{DD} = 15 \ V, \ R_L = 5.6 \ \Omega \\ \hline I_D \cong 2.7 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline \hline T_t & V_{DD} = 15 \ V, \ R_g = 1 \ \Omega \\ \hline \hline T_t & V_{DD} = 15 \ V, \ R_g = 1 \ \Omega \\ \hline \hline T_t & V_{DD} = 15 \ V, \ R_g = 1 \ \Omega \\ \hline \hline T_t & V_{DD} = 15 \ V, \ R_g = 1 \ \Omega \\ \hline \hline T_t & V_{SD} & I_S = 2.7 \ A, \ V_{GS} = 0 \ V \\ \hline \hline T_t & V_{SD} & I_S = 2.7 \ A, \ V_{GS} = 0 \ V \\ \hline \hline T_t & V_{SD} & I_S = 2.7 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \hline T_t & V_{SD} & I_S = 2.7 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \hline T_t & V_{SD} & I_S = 2.7 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \hline \hline T_t & V_{SD} & I_S = 2.7 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \hline \hline \hline T_t & V_{SD} & I_S = 2.7 \ A,$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Notes:

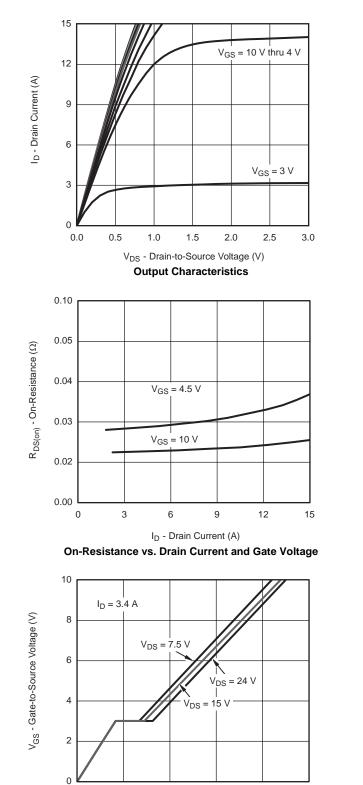
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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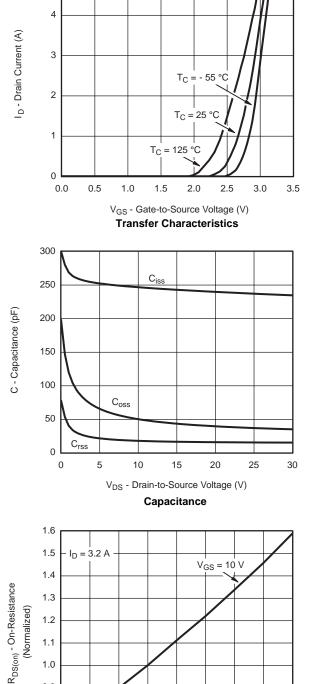
Qg - Total Gate Charge (nC)

Gate Charge

4

5

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



5

0.9

0.8

0.7

- 50

- 25

0

25

50

T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

75

100

125 150

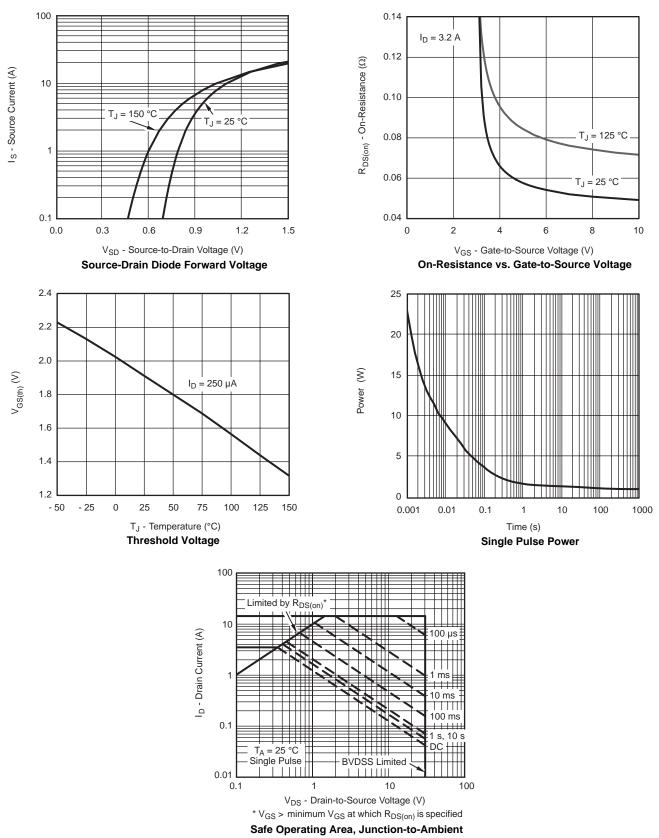
服务热线:400-655-8788

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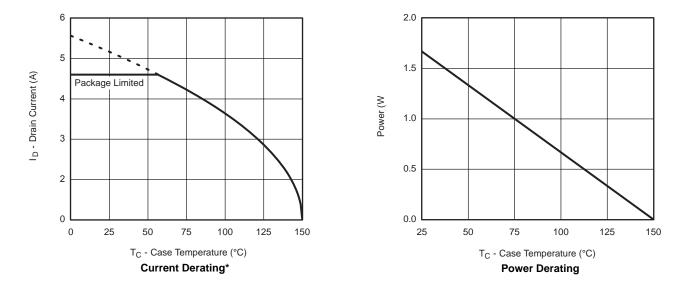
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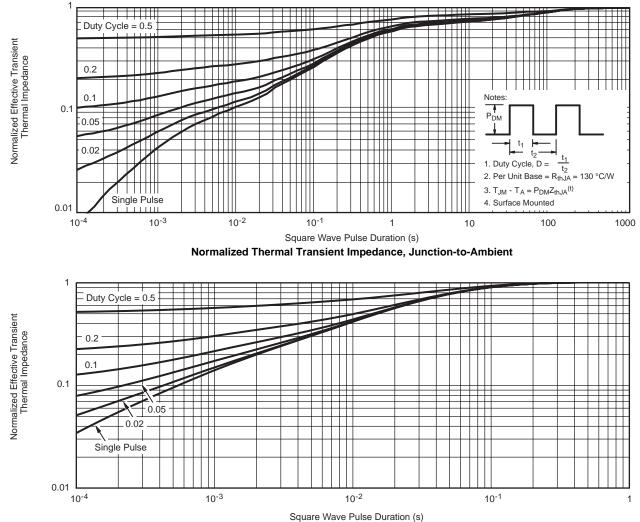


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.







Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01				



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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